

# STL18N65M5

Datasheet - preliminary data

### N-channel 650 V, 0.215 Ω typ., 15 A MDmesh<sup>™</sup> V Power MOSFET in a PowerFLAT<sup>™</sup> 5x6 HV package

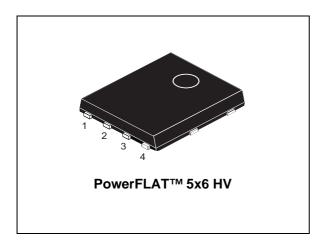
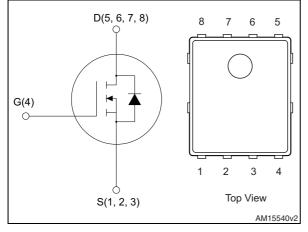


Figure 1. Internal schematic diagram



# Features

Order code	V <sub>DS</sub>	R <sub>DS(on)max</sub> .	Ι <sub>D</sub>
STL18N65M5	710 V	0.240 Ω	15 A <sup>(1)</sup>

1. The value is rated according to  $\mathsf{R}_{\mathsf{thj}\mathsf{-}\mathsf{case}}$  and limited by package.

- Outstanding R<sub>DS(on)</sub>\*area
- Extremely large avalanche performance
- Gate charge minimized
- Very low intrinsic capacitance
- 100% avalanche tested

### Applications

Switching applications

### Description

This device is an N-channel MDmesh<sup>™</sup> V Power MOSFET based on an innovative proprietary vertical process technology, which is combined with STMicroelectronics' well-known PowerMESH<sup>™</sup> horizontal layout structure. The resulting product has extremely low onresistance, which is unmatched among siliconbased Power MOSFETs, making it especially suitable for applications which require superior power density and outstanding efficiency.

#### Table 1. Device summary

Order code	Marking	Package	Packaging
STL18N65M5	18N65M5	PowerFLAT™ 5x6 HV	Tape and reel

June 2013

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This is preliminary information on a new product now in development or undergoing evaluation. Details are subject to change without notice.

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#### 1

# Electrical ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate-source voltage	± 25	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	15	A
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	6.5	A
I <sub>DM</sub> <sup>(1),(2)</sup>	Drain current (pulsed)	60	A
P <sub>TOT</sub> <sup>(1)</sup>	Total dissipation at $T_{C}$ = 25 °C	57	W
I <sub>AR</sub>	Avalanche current, repetitive or not- repetitive (pulse width limited by T <sub>j</sub> max)	4	А
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j = 25 \text{ °C}$ , $I_D = I_{AR}$ , $V_{DD} = 50 \text{ V}$ )	210	mJ
dv/dt <sup>(3)</sup>	Peak diode recovery voltage slope	15	V/ns
T <sub>stg</sub>	Storage temperature	- 55 to 150	°C
Тj	Max. operating junction temperature	150	°C

#### Table 2. Absolute maximum ratings

1. The value is rated according to  $\mathsf{R}_{thj\text{-}case}$  and limited by package.

2. Pulse width limited by safe operating area.

3. I\_{SD} ~\leq~ 15 A, di/dt  $~\leq~$  400 A/µs, V\_{Peak}  $\leq$  V\_{(BR)DSS}, V\_{DD} = 400 V.

#### Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	2.2	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-amb max	59	°C/W

1. When mounted on 1inch<sup>2</sup> FR-4 board, 2 oz Cu.



### 2 Electrical characteristics

( $T_C = 25$  °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage (V <sub>GS</sub> = 0)	I <sub>D</sub> = 1 mA	650			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 650 V V <sub>DS</sub> = 650 V, T <sub>C</sub> =125 °C			1 100	μA μA
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 25 V			± 100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7.5 A		0.215	0.240	Ω

#### Table 4. On /off states

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	1240	-	pF
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz,	-	32	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0$	-	3	-	pF
C <sub>o(tr)</sub> <sup>(1)</sup>	Equivalent capacitance time related	V <sub>DS</sub> = 0 to 520 V, V <sub>GS</sub> = 0	-	99	-	pF
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	v <sub>DS</sub> = 0 10 320 v, v <sub>GS</sub> = 0	-	30	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	3	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 520 V, I <sub>D</sub> = 7.5 A,	-	31	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 10 V	-	8	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 16)	-	14	-	nC

1.  $C_{oss \, eq}$  time related is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 

2.  $C_{oss eq.}$  energy related is defined as a constant equivalent capacitance giving the same stored energy as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time		-	36	-	ns
t <sub>r</sub>	Rise time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 9.5 \text{ A},$	-	7	-	ns
t <sub>d(off)</sub>	Turn-off delay time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see <i>Figure 17</i> and <i>20</i> )	-	9	-	ns
t <sub>f</sub>	Fall time		-	11	-	ns

Table 6. Switching times

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub> <sup>(1)</sup>	Source-drain current		-		15	А
I <sub>SDM</sub> <sup>(1)</sup> , <sup>(2)</sup>	Source-drain current (pulsed)		-		60	А
V <sub>SD</sub> <sup>(3)</sup>	Forward on voltage	I <sub>SD</sub> = 15 A, V <sub>GS</sub> = 0	-		1.5	V
t <sub>rr</sub>	Reverse recovery time		-	290		ns
Q <sub>rr</sub>	Reverse recovery charge	I <sub>SD</sub> = 15 A, di/dt = 100 A/μs V <sub>DD</sub> = 60 V (see <i>Figure 17</i> )	-	3.4		μC
I <sub>RRM</sub>	Reverse recovery current		-	23.5		А
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 15 A, di/dt = 100 A/µs	-	352		ns
Q <sub>rr</sub>	Reverse recovery charge	V <sub>DD</sub> = 60 V, T <sub>j</sub> = 150 °C	-	4		μC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 17)	-	24		A

1. The value is rated according to  ${\rm R}_{\rm thj\text{-}case}$  and limited by package.

2. Pulse width limited by safe operating area

3. Pulsed: pulse duration =  $300 \ \mu$ s, duty cycle 1.5%



### 2.1 Electrical characteristics (curves)

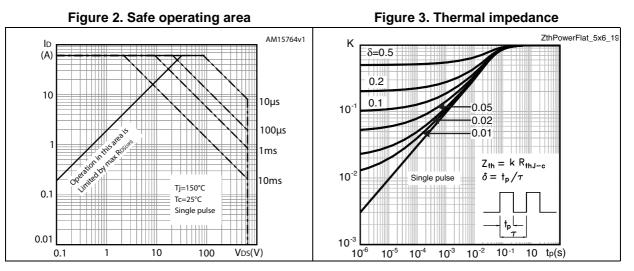
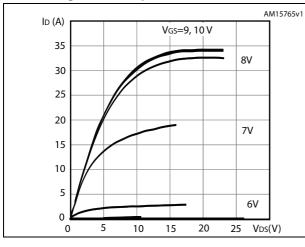
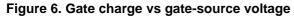


Figure 4. Output characteristics





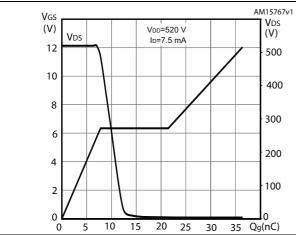
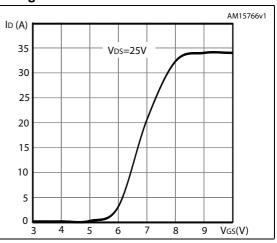
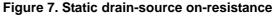
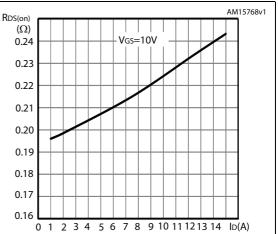


Figure 5. Transfer characteristics









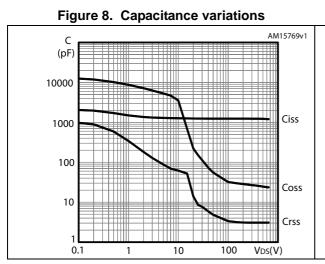


Figure 10. Normalized gate threshold voltage vs. temperature

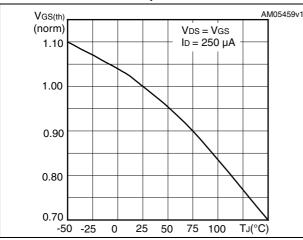
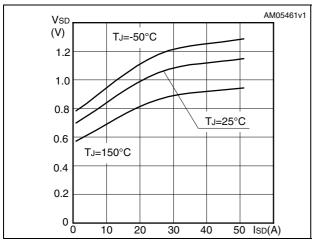


Figure 12. Drain-source diode forward characteristics



Electrical characteristics

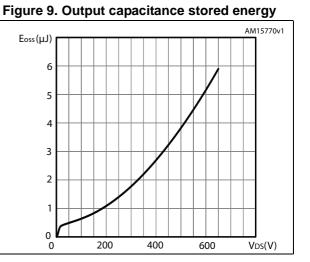


Figure 11. Normalized on-resistance vs. temperature

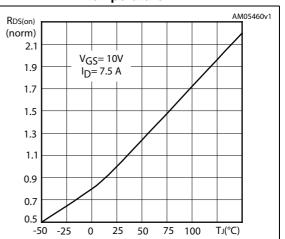
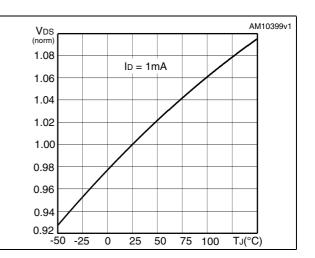
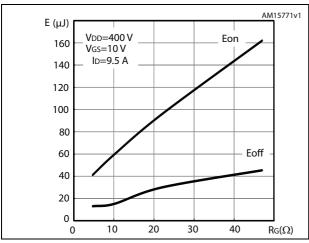


Figure 13. Normalized  $\mathsf{B}_{\mathsf{VDSS}}$  vs. temperature







# Figure 14. Switching losses vs gate resistance <sup>(1)</sup>

1. Eon including reverse recovery of a SiC diode



8/17



### 3 Test circuits

Figure 15. Switching times test circuit for resistive load

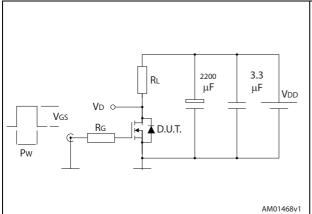


Figure 17. Test circuit for inductive load switching and diode recovery times

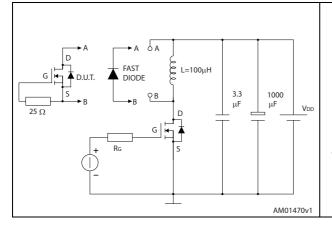
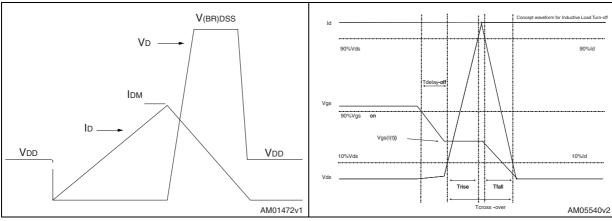
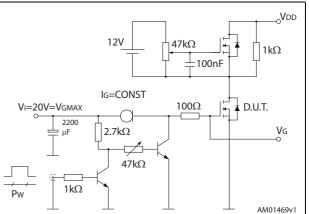


Figure 19. Unclamped inductive waveform





#### Figure 16. Gate charge test circuit



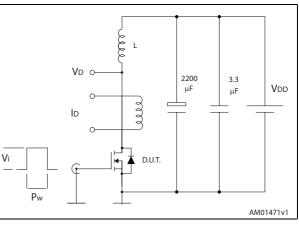


Figure 20. Switching time waveform



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# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



Dim.		mm			
	Min.	Тур.	Max.		
A	0.80		1.00		
A1	0.02		0.05		
A2		0.25			
b	0.30		0.50		
D	5.00	5.20	5.40		
E	5.95	6.15	6.35		
D2	4.30	4.40	4.50		
E2	3.10	3.20	3.30		
е		1.27			
L	0.50	0.55	0.60		
К	1.90	2.00	2.10		
aaa		0.15			
bbb		0.15			
ccc		0.10			
eee		0.10			

Table 8. PowerFLAT<sup>™</sup> 5x6 HV creepage



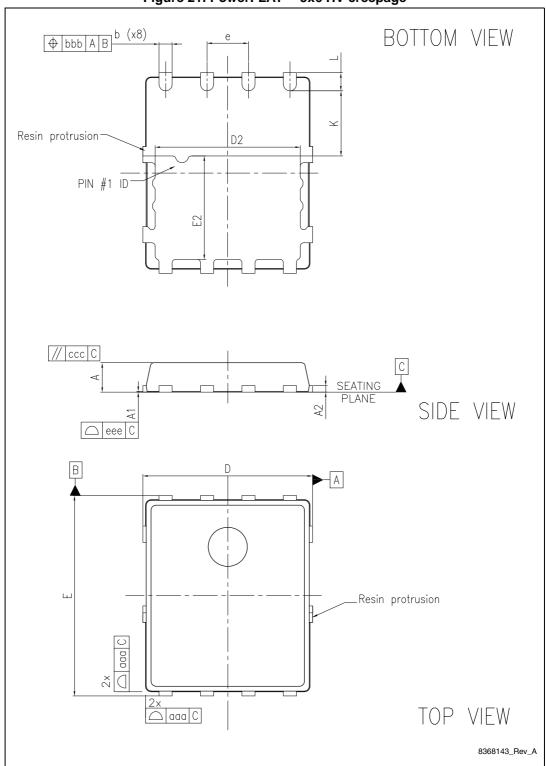


Figure 21. PowerFLAT™ 5x6 HV creepage



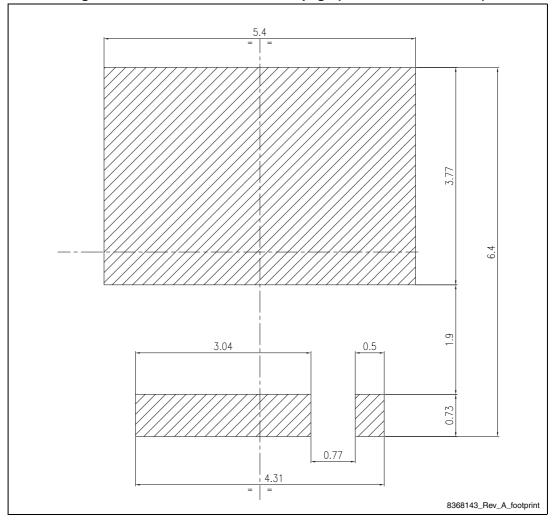


Figure 22. PowerFLAT<sup>™</sup> 5x6 HV creepage (dimensions are in mm)



# 5 Packaging mechanical data

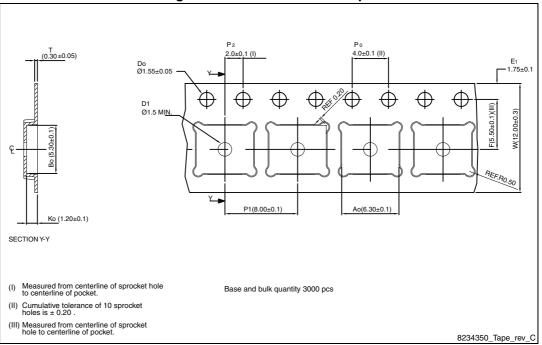
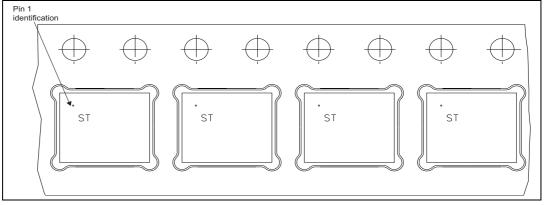
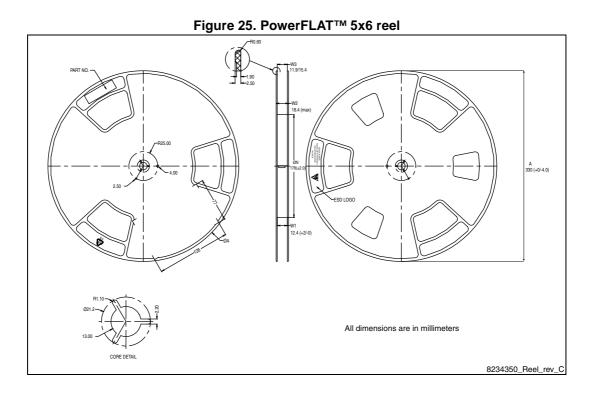


Figure 23. PowerFLAT™ 5x6 tape









# 6 Revision history

Date	Revision	Changes
24-Apr-2013	1	First release
26-Jun-2013	2	<ul> <li>Modified: Figure 6, 15, 16, 17, 18</li> <li>Minor text changes</li> </ul>

#### Table 9. Document revision history



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